COMPLIANT

HALOGEN

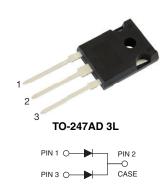
FREE



Vishay General Semiconductor

Dual High Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.51 \text{ V}$ at $I_F = 10 \text{ A}$



| PRIMARY CHARACTERISTICS | | | | | |
|---|----------------|--|--|--|--|
| I _{F(AV)} | 2 x 40 A | | | | |
| V_{RRM} | 150 V | | | | |
| I _{FSM} | 500 A | | | | |
| V_F at $I_F = 40 \text{ A } (T_J = 125 \text{ °C})$ | 0.69 V | | | | |
| T _J max. | 150 °C | | | | |
| Package | TO-247AD 3L | | | | |
| Circuit configuration | Common cathode | | | | |

FEATURES

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- · High efficiency operation
- Solder bath temperature 275 °C maximum, 10 s per JESD 22-B106
- AEC-Q101 qualified available:
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

MECHANICAL DATA

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix

meets JESD 201 class 2 whisker test

Polarity: as marked

Mounting torque: 10 in-lbs maximum

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|------------|-------------------------------|-------------|------|--|--|
| PARAMETER | | SYMBOL | VX80153PW | UNIT | | |
| Maximum repetitive peak reverse voltage | | V_{RRM} | 150 | V | | |
| Maximum average forward rectified current | per device | I _{F(AV)} | 80 | ^ | | |
| (fig. 1) | per diode | | 40 | А | | |
| Peak forward surge current 8.3 ms single half superimposed on rated load | sine-wave | I _{FSM} | 500 | А | | |
| Operating junction temperature range | | T _J ⁽¹⁾ | -40 to +150 | °C | | |
| Storage temperature range | | T _{STG} | -40 to +150 | | | |

Note

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{θ,JA}



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| ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted) | | | | | | |
|---|--|-------------------------|---------------------------------|-------|------|----------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| | I _F = 10 A | | - V _F ⁽¹⁾ | 0.61 | - | V |
| | I _F = 20 A | T _J = 25 °C | | 0.73 | - | |
| Instantanceus forward voltage per diede | I _F = 40 A | | | 0.93 | 1.06 | |
| Instantaneous forward voltage per diode | I _F = 10 A | T _J = 125 °C | | 0.51 | - | |
| | I _F = 20 A | | | 0.59 | - | |
| | I _F = 40 A | | | 0.69 | 0.74 | |
| Reverse current at rated V _R per diode | V _B = 100 V | T _J = 25 °C | I _R ⁽²⁾ | 0.003 | - | mA mA |
| | $V_{R} = 100 \text{ V}$ $T_{J} = 125 \text{ °C}$ | T _J = 125 °C | | 4.5 | - | |
| | V _R = 150 V | T _J = 25 °C | 1 (2) | - | 0.3 | |
| | v _R = 150 v | T _J = 125 °C | I _R ⁽²⁾ | 12 | 35 | IIIA |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 1900 | - | pF |

Notes

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 5 \text{ ms}$

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|-------------------------|-----|------|--|--|--|
| PARAMETER | R SYMBOL VX80153PW UNIT | | | | | |
| Typical thermal resistance per device | R ₀ JC (1) | 0.6 | °C/W | | | |

Note

(1) Thermal resistance junction-to-case to follow JEDEC® 51-14 transient dual interface test method (TDIM)

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|--------------|---------------|---------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| VX80153PW-M3/P | 5.64 | Р | 25/tube | Tube | | |
| VX80153PWHM3/P (1) | 5.64 | Р | 25/tube | Tube | | |

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C, unless otherwise noted)

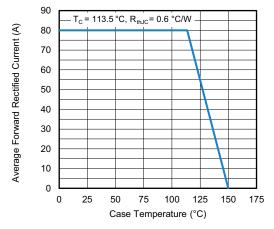


Fig. 1 - Maximum Forward Current Derating Curve

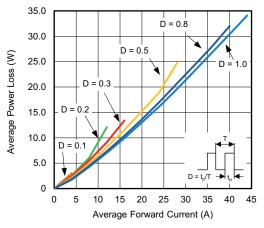


Fig. 2 - Average Power Loss Characteristics

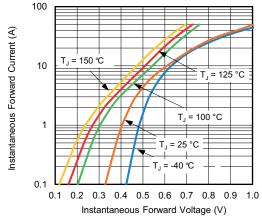


Fig. 3 - Typical Instantaneous Forward Characteristics

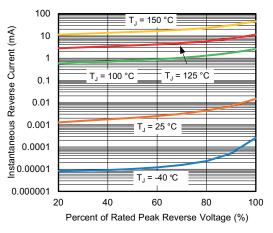


Fig. 4 - Typical Reverse Leakage Characteristics

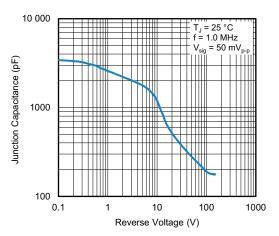


Fig. 5 - Typical Junction Capacitance

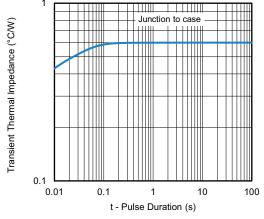
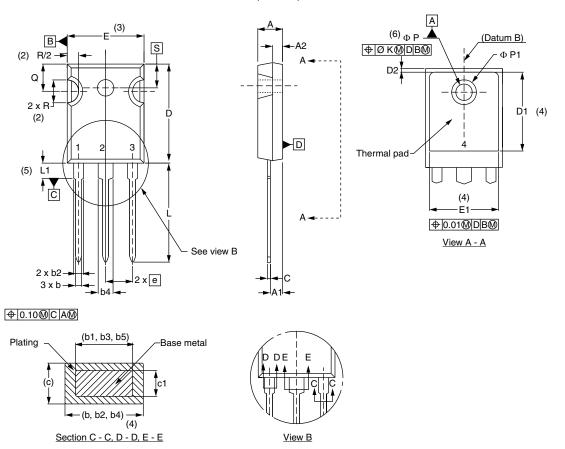


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in millimeters (inches) TO-247AD 3L



| SYMBOL | MILLIMETERS | | INC | NOTES | |
|---------|-------------|-------|-------|-------|-------|
| STWIBOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |

| SYMBOL | MILLIN | IETERS | INC | NOTES | |
|---------|----------|--------|-------|-------|-------|
| STWIDOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| D2 | 0.51 | 1.30 | 0.020 | 0.051 | |
| E | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.46 | - | 0.53 | - | |
| е | 5.46 | BSC | 0.215 | BSC | |
| ØК | 0.2 | 0.254 | |)10 | |
| L | 19.81 | 20.32 | 0.780 | 0.800 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 6.98 | - | 0.275 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 BSC | | 0.217 | BSC | |
| | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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